

Electronic Acknowledgement Receipt

EFS ID:	1132596
Application Number:	10629106
Confirmation Number:	6373
Title of Invention:	Method of plating a semiconductor structure
First Named Inventor:	Matthias Bonkabeta
Customer Number:	23720
Filer:	J. Mike Amerson/Mary Paul
Filer Authorized By:	J. Mike Amerson
Attorney Docket Number:	2000.108300
Receipt Date:	28-JUL-2006
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Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		Response_to_Office_Action_Dated_5_08_06.pdf	145833	yes	17

	Multipart Description		
	Doc Desc	Start	End
	Amendment - After Non-Final Rejection	1	1
	Claims	2	10
Applicant Arguments/Remarks Made in an Amendment		11	17
Warnings:			
Information:			
		Total Files Size (in bytes):	145833

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New Applications Under 35 U.S.C. 111
If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.